

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Akira BANDO</td> <td>02/22/2012</td> </tr> <tr> <td>Yasuhiro KIYOFUJI</td> <td>02/24/2012</td> </tr> <tr> <td>Masaya ICHINOSE</td> <td>02/24/2012</td> </tr> <tr> <td>Hiromitsu SAKAI</td> <td>02/24/2012</td> </tr> <tr> <td>Yasuhiro IMAZU</td> <td>02/24/2012</td> </tr> </tbody> </table>	Name	Execution Date	Akira BANDO	02/22/2012	Yasuhiro KIYOFUJI	02/24/2012	Masaya ICHINOSE	02/24/2012	Hiromitsu SAKAI	02/24/2012	Yasuhiro IMAZU	02/24/2012	
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RECEIVING PARTY DATA													
Name:	Hitachi, Ltd.												
Street Address:	6-6, Marunouchi 1-chome												
City:	Chiyoda-ku, Tokyo												
State/Country:	JAPAN												
PROPERTY NUMBERS Total: 1													
Property Type	Number												
Application Number:	13420718												
CORRESPONDENCE DATA													
Fax Number:	(202)628-8844												
Phone:	2026242500												
Email:	therring@crowell.com												
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>													
Correspondent Name:	Crowell & Moring LLP												
Address Line 1:	P.O. Box 14300												
Address Line 2:	Intellectual Property Group												
Address Line 4:	Washington, DISTRICT OF COLUMBIA 20044-4300												
ATTORNEY DOCKET NUMBER:	056203.64386US												
NAME OF SUBMITTER:	Michael H. Jacobs												
Total Attachments: 1 source=64386US_EXECUTED_ASGNMT#page1.tif													

OP \$40.00 13420718

ASSIGNMENT

(譲渡証)

056203.64386US

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI, LTD., a corporation organized under the laws of Japan, located at 6-6, Marunouchi 1-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SEMICONDUCTOR POWER CONVERSION APPARATUS

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD.

Signed on the date(s) indicated aside signatures:

	INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1)	<u>Akira Bando</u> Akira BANDO	<u>2/22/2012</u>
2)	<u>Yasuhiro Kiyofuji</u> Yasuhiro KIYOFUJI	<u>2/24/2012</u>
3)	<u>Masaya Ichinose</u> Masaya ICHINOSE	<u>2/24/2012</u>
4)	<u>Hiromitsu Sakai</u> Hiromitsu SAKAI	<u>2/24/2012</u>
5)	<u>Yasuhiro Imazu</u> Yasuhiro IMAZU	<u>2/24/2012</u>
6)	_____	_____
7)	_____	_____
8)	_____	_____
9)	_____	_____
10)	_____	_____

PATENT

RECORDED: 04/27/2012

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